

SILICON EPITAXIAL TRANSISTORS

PNP transistors in a microminiature SMD package (SOT-223).

They are primarily intended for use in telephony and professional communication equipment.

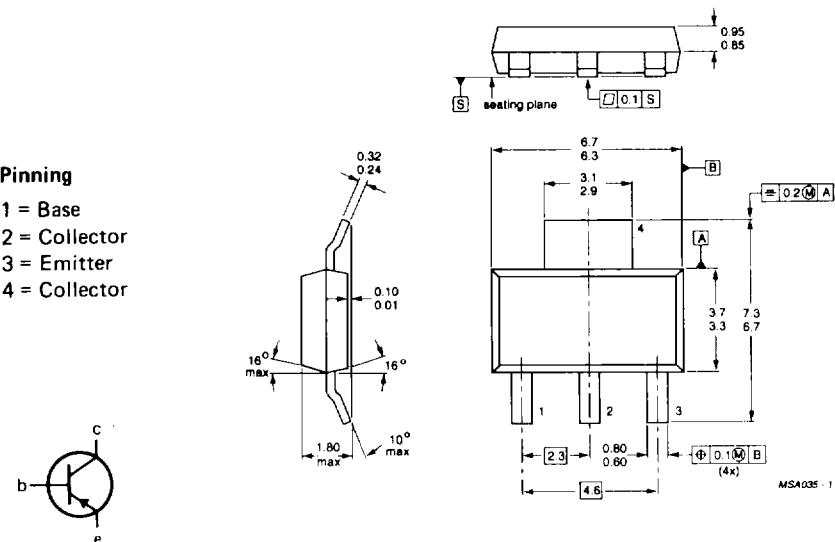
QUICK REFERENCE DATA

		PZTA92	PZTA93	
Collector-base voltage (open emitter)	$-V_{CBO}$	max.	300	200 V
Collector-emitter voltage (open base)	$-V_{CEO}$	max.	300	200 V
Emitter-base voltage (open collector)	$-V_{EBO}$	max.	5	V
Collector current (DC)	$-I_C$	max.	500	mA
Total power dissipation up to $T_{amb} = 25^\circ C$	P_{tot}	max.	1,5	W
DC current gain $-I_C = 10 \text{ mA}; -V_{CE} = 10 \text{ V}$	h_{FE}	min.	40	
Transition frequency at $f = 100 \text{ MHz}$ $-I_C = 10 \text{ mA}; -V_{CE} = 20 \text{ V}$	f_T	min.	50	MHz
Collector-base capacitance at $f = 1 \text{ MHz}$ $I_E = 0; -V_{CB} = 20 \text{ V}$	C_C	max.	6	8 pF

MECHANICAL DATA

Dimensions in mm

Fig. 1 SOT-223



RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

			PZTA92	PZTA93
Collector-base voltage (open emitter)	$-V_{CBO}$	max.	300	200 V
Collector-emitter voltage (open base)	$-V_{CEO}$	max.	300	200 V
Emitter-base voltage (open collector)	$-V_{EBO}$	max.	5	V
Collector current (DC)	$-I_C$	max.	500	mA
Total power dissipation *	P_{tot}	max.	1,5	W
up to $T_{amb} = 25^\circ\text{C}$				
Storage temperature range	T_{stg}		-65 to +150	$^\circ\text{C}$
Junction temperature	T_j	max.	150	$^\circ\text{C}$

THERMAL CHARACTERISTICS

Thermal resistance from junction to ambient*	$R_{th j-a}$	=	83,3	K/W
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CHARACTERISTICS

$T_{amb} = 25^\circ\text{C}$ unless otherwise specified

			PZTA92	PZTA93
Collector-emitter breakdown voltage $-I_C = 1 \text{ mA}; I_B = 0$	$-V_{(BR)CEO}$	min.	300	200 V
Collector-base breakdown voltage $-I_C = 100 \mu\text{A}; I_E = 0$	$-V_{(BR)CBO}$	min.	300	200 V
Collector cut-off current $-V_{CB} = 200 \text{ V}; I_E = 0$ $-V_{CB} = 160 \text{ V}; I_E = 0$	$-I_{CBO}$	max. max.	0,25 —	$-\mu\text{A}$ 0,25 μA
Emitter-base breakdown voltage $-I_E = 100 \mu\text{A}; I_C = 0$	$-V_{(BR)EBO}$	min.	5	V
Emitter cut-off current $I_C = 0; -V_{BE} = 3 \text{ V}$	$-I_{EBO}$	max.	0,1	μA
Collector-base capacitance at $f = 1 \text{ MHz}$; $I_E = 0; -V_{CB} = 20 \text{ V}$	C_c	max.	6	8 pF
Saturation voltages $-I_C = 20 \text{ mA}; -I_B = 2 \text{ mA}$ $-I_C = 20 \text{ mA}; -I_B = 2 \text{ mA}$	$-V_{CEsat}$ $-V_{BEsat}$	max. max.	0,5 0,9	V
DC current gain** $-I_C = 1 \text{ mA}; -V_{CE} = 10 \text{ V}$ $-I_C = 10 \text{ mA}; -V_{CE} = 10 \text{ V}$ $-I_C = 30 \text{ mA}; -V_{CE} = 10 \text{ V}$	h_{FE}	min. min. min.	25 40 25	

* Device mounted on an epoxy printed circuit board 40 mm x 40 mm x 1,5 mm;
mounting pad for the collector lead min. 6 mm².

** Pulse test conditions: $t_p = 300 \mu\text{s}$; duty cycle $\leq 2\%$.